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Fairchild Semiconductor FQP33N10

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FQP33N10 N-Channel QFET[®] MOSFET

100 V, 33 A, 52 mΩ

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

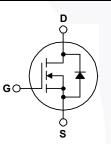
November 2013

FQP33N10 — N-Channel QFET[®] MOSFET

Features

- 33 A, 100 V, $R_{DS(on)}$ = 52 m Ω (Max.) @ V_{GS} = 10 V, I_D = 16.5 A
- Low Gate Charge (Typ. 38 nC)
- Low Crss (Typ. 62 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQP33N10	Unit
V _{DSS}	Drain-Source Voltage		100	V
I _D	Drain Current - Continuous ($T_C = 25^\circ$	C)	33	A
	- Continuous (T _C = 100	23	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	132	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	435	mJ
I _{AR}	Avalanche Current	(Note 1)	33	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		127	W
	- Derate above 25°C		0.85	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Solderin 1/8" from Case for 5 seconds	g,	300	°C

Thermal Characteristics

Symbol	Parameter	FQP33N10	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case, Max.	1.18	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

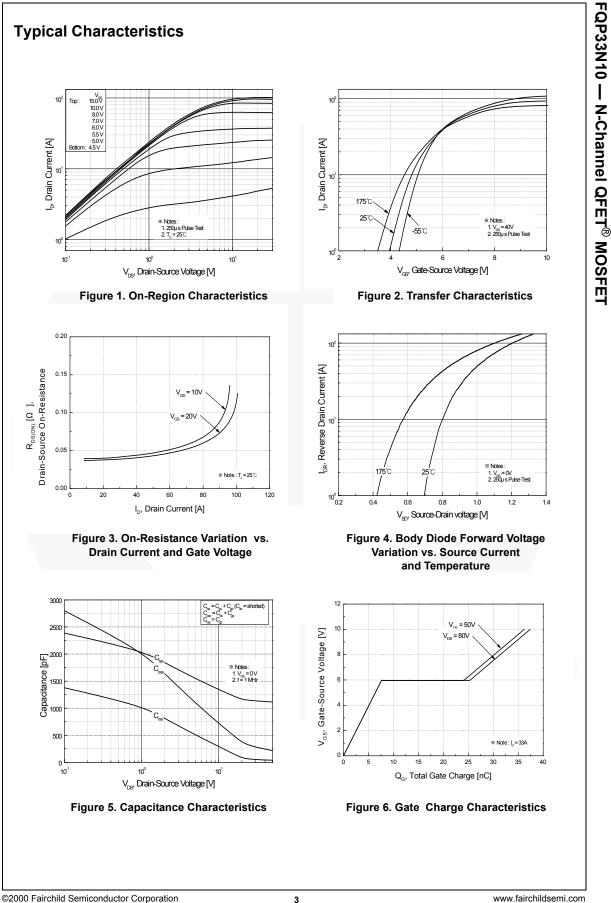
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FQP33	mber	Top Mark	Package	Packing Method	Reel Size	Ta	ape Widt	th Q	uantity
	N10	FQP33N10	TO-220	Tube	N/A		N/A	5	0 units
				-	ľ			ľ	
	cal Cr	naracteristics	T _C = 25°C	unless otherwise noted.		Min	True	Maria	11 14
Symbol		Parameter		Test Condit	lions	Min	Тур	Мах	Unit
Off Cha	aracter	istics				T	r	r	
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250	μA	100			V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		I_D = 250 μ A, Referenced to 25°C			0.11		V/°C	
I _{DSS}				V _{DS} = 100 V, V _{GS} = 0 V				1	μA
088	Zero Gate Voltage Drain Current		$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$				10	μA	
I _{GSSF}	Gate-E	Body Leakage Curren	t. Forward	$V_{GS} = 25 V, V_{DS} = 0 V$				100	nA
I _{GSSR}		Body Leakage Curren	-	$V_{GS} = -25 V, V_{DS} = 0 V$				-100	nA
On Cha	reator	iation					P		
On Cha		ISTICS hreshold Voltage		V _{DS} = V _{GS} , I _D = 250	μΔ	2.0		4.0	V
V _{GS(th)} R _{DS(on)}		Drain-Source		$V_{\rm DS} = V_{\rm GS}, v_{\rm D} = 230$ $V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 16.5 \text{ A}$		2.0	0.040	0.052	ν
0		On-Resistance		$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 16.5 \text{ A}$					
9 _{FS}	Forwar	rd Transconductance		v _{DS} = 40 v, 1 _D = 10.	5 A		22		S
Dynam	ic Cha	racteristics							
C _{iss}	Input C	Capacitance		V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			1150	1500	pF
C _{oss}	Output	Capacitance					320	420	pF
C _{rss}	Revers	se Transfer Capacitar	nce				62	80	pF
Switchi	ina Ch	aracteristics							
t _{d(on)}		n Delay Time					15	40	ns
t _r		n Rise Time		$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 33 \text{ J}$	А,		195	400	ns
t _{d(off)}	Turn-C	off Delay Time		R _G = 25 Ω			80	170	ns
t _f		off Fall Time			(Note 4)		110	230	ns
	Total G	Sate Charge		V _{DS} = 80 V, I _D = 33 J	Δ		38	51	nC
		Source Charge		$V_{GS} = 10 V$, , , , , , , , , , , , , , , , , , ,		7.5		nC
Q _g		U		V _{GS} – 10 V (Note 4)			18		nC
Q _g Q _{gs} Q _{gd}		Drain Charge							
Q _g Q _{gs} Q _{gd}	Gate-D								
Q _g Q _{gs} Q _{gd} Drain-S	Gate-D	Diode Characte		d Maximum Rat	ings			22	۸
Q _g Q _{gs} Q _{gd} Drain-S	Gate-D Cource Maxim	Diode Characte	-Source Dio	de Forward Current	ings			33	A
Q _g Q _{gs} Q _{gd} Drain-S	Gate-D Cource Maxim Maxim	Diode Characte um Continuous Drain um Pulsed Drain-Sou	-Source Dio urce Diode F	de Forward Current orward Current				132	Α
Q_g Q_{gs} Q_{gd} Drain-S I_S I_{SM} V_{SD}	Gate-D Gource Maxim Maxim Drain-S	Diode Characte um Continuous Drain um Pulsed Drain-Sou Source Diode Forwar	-Source Dio urce Diode F	de Forward Current orward Current V _{GS} = 0 V, I _S = 33 A				132 1.5	A V
Q _g Q _{gs} Q _{gd}	Gate-D OUICE Maxim Maxim Drain-S Revers	Diode Characte um Continuous Drain um Pulsed Drain-Sou	-Source Dio urce Diode F	de Forward Current orward Current				132	Α

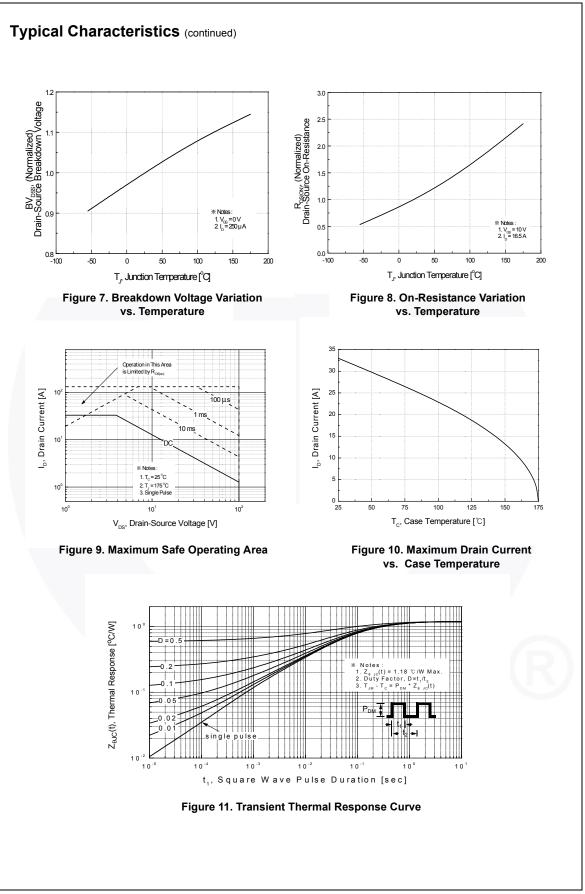
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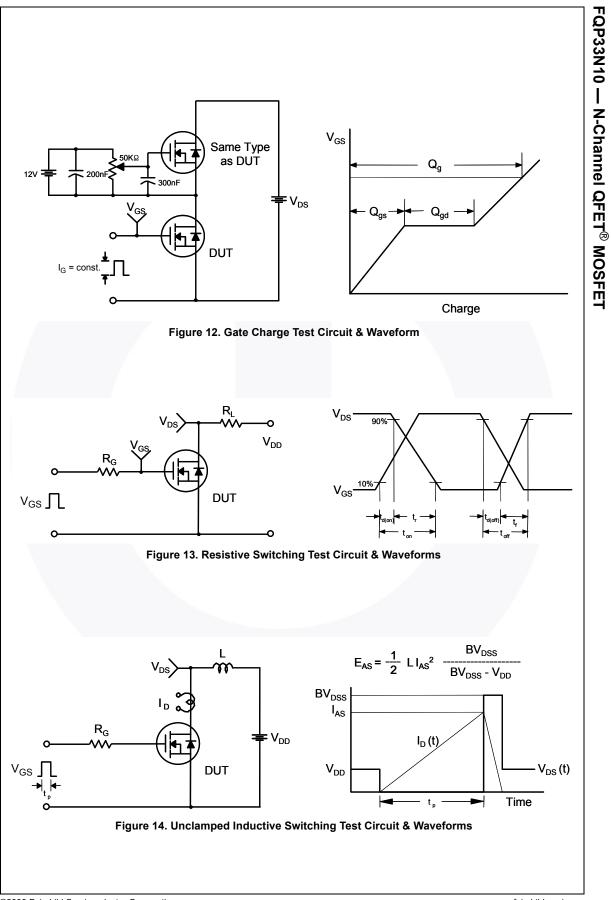
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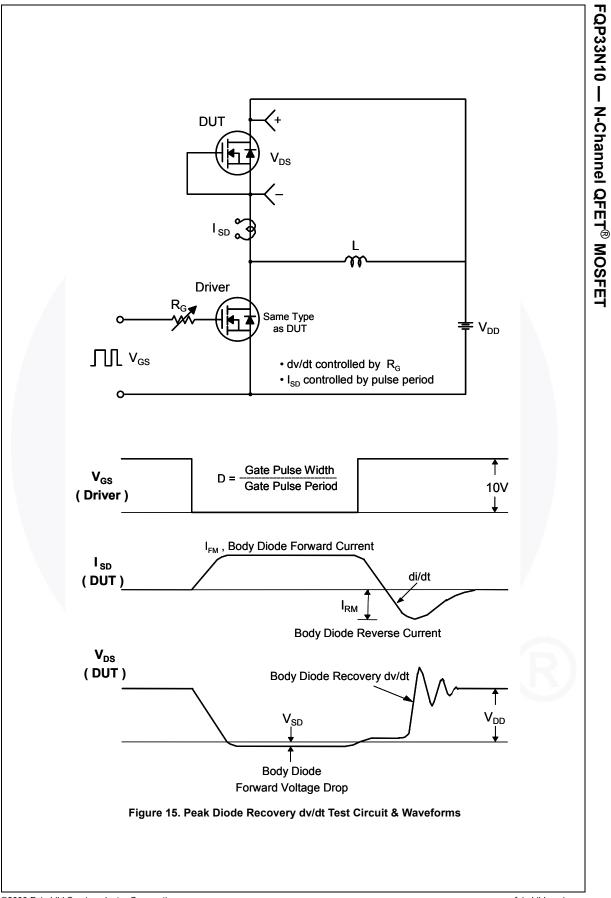


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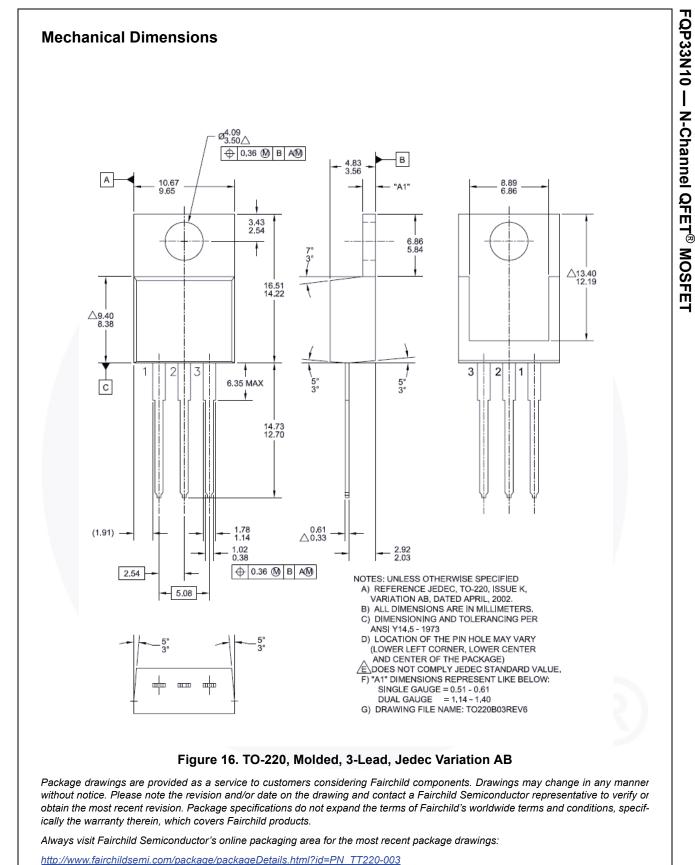






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